

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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HF0402B102R-10

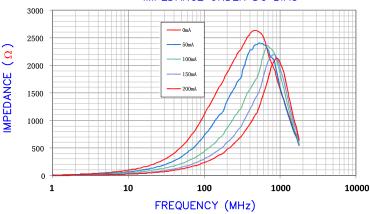
UNCONTROLLED DOCUMENT

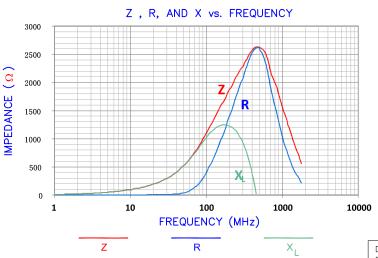
PHYSICAL DIMENSIONS:

A 1.01 [.040] ± 0.18 [.007]

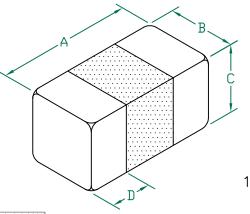
D 0.30 [.012] MAX.

Z vs FREQUENCY IMPEDANCE UNDER DC BIAS





AGILENT E4991A RF Impedance/Material Analyzer HP 16194A Test Fixture. TEST REF. 400-10-0057

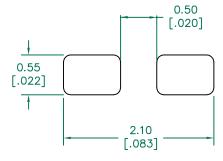


ELECTRICAL CHARACTERISTICS:										
	Z@1000MHz (Ω)	Z@100MHz (Ω)	DCR (Ω)	RATED CURRENT						
Nominal	1800	1000								
Minimum	1080	750	_							
Maximum	2520	1250	1.25	200mA						

NOTES: UNLESS OTHERWISE SPECIFIED

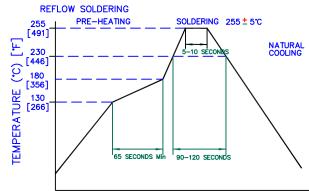
- 1. TAPED AND REELED PER CURRENT EIA SPECIFICATIONS 7" REELS, 10K PCS/REEL, PAPER CARRIER TAPE
- 2. TERMINATION FINISH IS 100% TIN.
- 3. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 4. OPERATING TEMPERATURE TEMP: -40° C~+125° C (INCLUDING SELF-HEATING)

LAND PATTERNS FOR REFLOW SOLDERING



(For wave soldering, add 0.763 (.030 to this dimension.)

RECOMMENDED SOLDERING CONDITIONS



	DIMENSIONS ARE IN mm [INCHI	ES].		This print is the property of Laird Tech. and is loaned in confidence subject to return upon request and with the understanding that no copies shall be made without the written consent of Laird Tech. All rights to design or invention are reserved.	L	air(ď
				PROJECT/PART NUMBER:	REV	PART TYPE:	DRAWN BY:
				HF0402B102R-10	В	CO-FIRE	JUN
В	ADD 1000MHz IMPEDANCE	06/20/13			1	00 11112	55.1
	ADD OPERATING TEMPERATURE			DATE: 06/11/10 SCALE	· NTS	SHEET:	
Α	ORIGINAL DRAFT	06/11/10	JUN	CAD #			of 2
REV	DESCRIPTION	DATE	INT	CAD # HF0402B102R-10-B TOOL	-	1 -	0